IPC ASSOCIATION CONNECTED ELECTRONICS INDUST	© Copyright 2005. IPC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both This docum level parts,	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ials and Mfc Information			
upplier Info	rmation								,			<u> </u>		
Company name*			Company unique ID			Unique ID Authority					Response Date*			
nsemi						I					2023-06-08			
Contact Name			Title - Contact			Phone - Contact*					Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
uthorized Repr	esentative*		Title - Representative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Reque	ester Item Number	Mfr Item Number Mfr Ite		Mfr Item Name	fr Item Name		Date Version Manufacturing Site		V	Weight*	UOM	Unit Type		
		NCL3016	51MNTXG	Constant-Current B High Power LEDs	Buck Regulator for Driving	g 2023-06-0	8				3	0.0	mg	Each
Ianufacturin	g Proccess Information	on												
Terminal Plating / Grid Array Material T		Terminal Base Alloy J-STD-020 MSL R		STD-020 MSL Rating	Peak Process Body Temperature Max		Max Time at Peak	Temperati	are Num	ber of Reflow Cy	cles			
Matte Tin (Sn) - annealed		C	CU Alloy 1			260		C		30	secono	ds 3		
omments														
vel 1 - maximun	n time at peak temperature	e during sol	dering is 10-3	0 seconds										
or more informa	ation regarding material co	omposition 1	olease refer to	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have not with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	ceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.3	mg	Supplier	Silicon (Si)	7440-21-3		0.3	mg
Die Attach	0.79	mg		Epoxy resin	proprietary data		0.0198	mg
			Supplier	Silver (Ag)	7440-22-4		0.6676	mg
			Supplier	Phenolic Resin	Proprietary Data		0.0198	mg
			Supplier	Inorganic filler	Proprietary Data		0.0198	mg
			Supplier	Dicyandiamine	461-58-5		0.0039	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.0593	mg
Lead Frame	12.41	mg	Supplier	Silver (Ag)	7440-22-4		2.4448	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0124	mg
			Supplier	Iron (Fe)	7439-89-6		0.1861	mg
			Supplier	Copper (Cu)	7440-50-8		9.7667	mg
Mold Compound-Black	15.0	mg	Supplier	Epoxy and Phenolic Resin	40216-08-8		1.2	mg
			Supplier	Carbon Black (C)	1333-86-4		0.075	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.3	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		12.975	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.45	mg
Plating	0.6	mg	Supplier	Tin (Sn)	7440-31-5		0.6	mg
Wire Bond - Au	0.9	mg	Supplier	Gold (Au)	7440-57-5		0.9	mg